TOSHIBA Photocoupler GaAlAs IRED & Photo-Diode Array

TLP191B

Telecommunication
Programmable Controllers
MOS Gate Driver
MOS FET Gate Driver

The TOSHIBA mini-flat coupler TLP191B is a small outline coupler, suitable for surface mount assembly.

The TLP191B consists of a GaAlAs infrared light emitting diode, optically coupled to a series connected photo diode array with shunt resistor which is suitable for MOS FET gate drive.

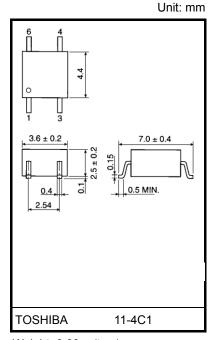
TLP191B: Mini Flat Package, 4Pin, one circuit

Open voltage: 7.0 V (min)
Short current: 24 μA (min)

• Isolation voltage: 2500 Vrms (min)

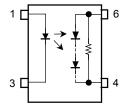
• UL recognized: UL1577, file no.E67349

• cUL approved :CSA Component Acceptance Service No. 5A, File No.E67349



Weight: 0.09 g (typ.)

Pin Configuration (top view)



- 1 . Anode
- 3 . Cathode
- 4 . Cathode
- 6 . Anode

Absolute Maximum Ratings (Ta = 25°C)

	Characteristic	Symbol	Rating	Unit
	Forward current	ΙF	50	mA
	Forward current derating (Ta ≥ 25°C)	ΔI _F /°C	-0.5	mA/°C
	Pulse forward current (100 μs pulse, 100 pps)	I _{FP}	1	Α
LED	Reverse voltage	VR	3	V
	Diode power dissipation	P _D	100	mW
	Diode power dissipation derating (Ta >25°C)	ΔP_D /°C	-1.0	mW/°C
	Junction temperature	Tj	125	°C
	Forward current	I _{FD}	50	μΑ
Detector	Reverse voltage	V_{RD}	10	٧
Detector	Output power dissipation	Po	0.5	mW
	Junction temperature	Tj	125	°C
Storage ter	T _{stg}	-55 to 125	°C	
Operating t	T _{opr}	-40 to 85	°C	
Lead solde	T _{sol}	260	°C	
Isolation vo	BVS	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Note 1: Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

2

Recommended Operating Conditions

Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	l _F	_	20	25	mA
Operating temperature	T _{opr}	-25	1	85	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	V _F	I _F = 10 mA	1.2	1.4	1.7	V
	Reverse current	I _R	V _R = 3 V	_	_	10	μΑ
	Capacitance between terminals	C _T	V = 0 V, f = 1 MHz	_	30	60	pF
Detector	Forward voltage	V_{FD}	I _{FD} = 10 μA	_	7	_	٧
	Reverse current	I _{RD}	V _{RD} = 10 V	_	7	_	μΑ

Coupled Electrical Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	MIn	Тур.	Max	Unit
Open voltage	V _{OC}	I _F = 20 mA	7	8	_	V
Short current	Isc	I _F = 20 mA	24	40	_	μΑ

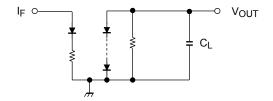
Isolation Characteristics (Ta = 25°C)

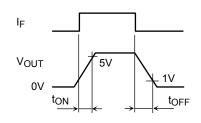
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz	_	0.8	_	pF
Isolation resistance	R _S	V _S = 500 V, R.H. ≤ 60%	5×10 ¹⁰	10 ¹⁴	_	Ω
		AC, 60 s	2500	_	_	Vrma
Isolation voltage	BV_S	AC, 1 s in oil	— 5000	5000	_	Vrms
		DC, 60 s in oil	_	5000	_	Vdc

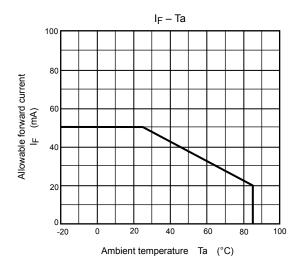
Switching Characteristics (Ta = 25°C)

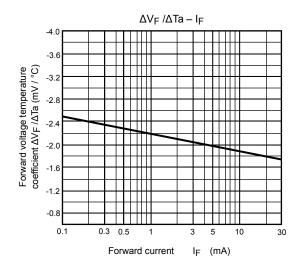
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}	I _F = 20 mA, C _L = 1000 pF	_	0.2	_	mo
Turn-off time	toff	(Note1)	_	3	_	ms

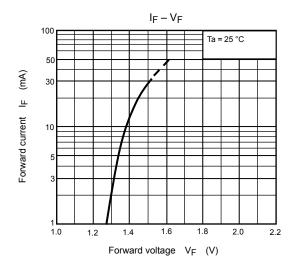
Note 1: Switching time test circuit

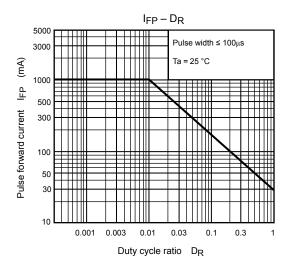


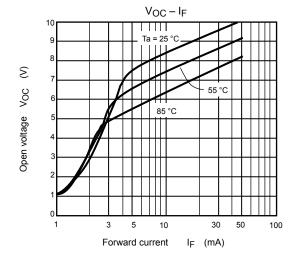


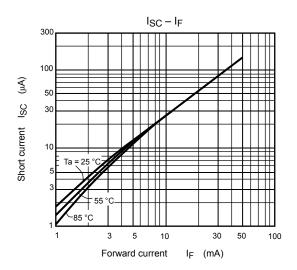












4

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